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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

|                            |   |
|----------------------------|---|
| Product Status             | Active  |
| Core Processor             | AVR   |
| Core Size                  | 8/16-Bit  |
| Speed                      | 32MHz   |
| Connectivity               | I <sup>2</sup> C, IrDA, SPI, UART/USART, USB  |
| Peripherals                | Brown-out Detect/Reset, DMA, POR, PWM, WDT  |
| Number of I/O              | 50  |
| Program Memory Size        | 128KB (64K x 16)  |
| Program Memory Type        | FLASH   |
| EEPROM Size                | 2K x 8  |
| RAM Size                   | 8K x 8  |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 3.6V   |
| Data Converters            | A/D 16x12b; D/A 2x12b   |
| Oscillator Type            | Internal  |
| Operating Temperature      | -40°C ~ 85°C (TA)   |
| Mounting Type              | Surface Mount   |
| Package / Case             | 64-TQFP   |
| Supplier Device Package    | 64-TQFP (14x14)   |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/microchip-technology/atxmega128a3u-aur">https://www.e-xfl.com/product-detail/microchip-technology/atxmega128a3u-aur</a> |

## 6. AVR CPU

### 6.1 Features

- 8/16-bit, high-performance Atmel AVR RISC CPU
  - 142 instructions
  - Hardware multiplier
- 32x8-bit registers directly connected to the ALU
- Stack in RAM
- Stack pointer accessible in I/O memory space
- Direct addressing of up to 16MB of program memory and 16MB of data memory
- True 16/24-bit access to 16/24-bit I/O registers
- Efficient support for 8-, 16-, and 32-bit arithmetic
- Configuration change protection of system-critical features

### 6.2 Overview

All Atmel AVR XMEGA devices use the 8/16-bit AVR CPU. The main function of the CPU is to execute the code and perform all calculations. The CPU is able to access memories, perform calculations, control peripherals, and execute the program in the flash memory. Interrupt handling is described in a separate section, refer to “[Interrupts and Programmable Multilevel Interrupt Controller](#)” on page 30.

### 6.3 Architectural Overview

In order to maximize performance and parallelism, the AVR CPU uses a Harvard architecture with separate memories and buses for program and data. Instructions in the program memory are executed with single-level pipelining. While one instruction is being executed, the next instruction is pre-fetched from the program memory. This enables instructions to be executed on every clock cycle. For details of all AVR instructions, refer to <http://www.atmel.com/avr>.

### 36.1.5 I/O Pin Characteristics

The I/O pins comply with the JEDEC LVTTL and LVCMOS specification and the high- and low level input and output voltage limits reflect or exceed this specification.

**Table 36-7. I/O pin characteristics.**

| Symbol                             | Parameter                   | Condition             |                      | Min.         | Typ.          | Max.           | Units     |
|------------------------------------|-----------------------------|-----------------------|----------------------|--------------|---------------|----------------|-----------|
| $I_{OH}^{(1)}$ /<br>$I_{OL}^{(2)}$ | I/O pin source/sink current |                       |                      | -20          |               | 20             | mA        |
| $V_{IH}$                           | High Level Input Voltage    | $V_{CC} = 2.7 - 3.6V$ |                      | 2            |               | $V_{CC} + 0.3$ | V         |
|                                    |                             | $V_{CC} = 2.0 - 2.7V$ |                      | $0.7*V_{CC}$ |               | $V_{CC} + 0.3$ |           |
|                                    |                             | $V_{CC} = 1.6 - 2.0V$ |                      | $0.8*V_{CC}$ |               | $V_{CC} + 0.3$ |           |
| $V_{IL}$                           | Low Level Input Voltage     | $V_{CC} = 2.7 - 3.6V$ |                      | -0.3         |               | 0.8            | V         |
|                                    |                             | $V_{CC} = 2.0 - 2.7V$ |                      | -0.3         |               | $0.3*V_{CC}$   |           |
|                                    |                             | $V_{CC} = 1.6 - 2.0V$ |                      | -0.3         |               | $0.2*V_{CC}$   |           |
| $V_{OH}$                           | High Level Output Voltage   | $V_{CC} = 3.0 - 3.6V$ | $I_{OH} = -2mA$      | 2.4          | $0.94*V_{CC}$ |                | V         |
|                                    |                             | $V_{CC} = 2.3 - 2.7V$ | $I_{OH} = -1mA$      | 2.0          | $0.96*V_{CC}$ |                |           |
|                                    |                             |                       | $I_{OH} = -2mA$      | 1.7          | $0.92*V_{CC}$ |                |           |
|                                    |                             | $V_{CC} = 3.3V$       | $I_{OH} = -8mA$      | 2.6          | 2.9           |                |           |
|                                    |                             | $V_{CC} = 3.0V$       | $I_{OH} = -6mA$      | 2.1          | 2.6           |                |           |
| $V_{OL}$                           | Low Level Output Voltage    | $V_{CC} = 1.8V$       | $I_{OH} = -2mA$      | 1.4          | 1.6           |                | V         |
|                                    |                             | $V_{CC} = 3.0 - 3.6V$ | $I_{OL} = 2mA$       |              | $0.05*V_{CC}$ | 0.4            |           |
|                                    |                             | $V_{CC} = 2.3 - 2.7V$ | $I_{OL} = 1mA$       |              | $0.03*V_{CC}$ | 0.4            |           |
|                                    |                             |                       | $I_{OL} = 2mA$       |              | $0.06*V_{CC}$ | 0.7            |           |
|                                    |                             | $V_{CC} = 3.3V$       | $I_{OL} = 15mA$      |              | 0.4           | 0.76           |           |
|                                    |                             | $V_{CC} = 3.0V$       | $I_{OL} = 10mA$      |              | 0.3           | 0.64           |           |
| $I_{IN}$                           | Input Leakage Current       | $T = 25^{\circ}C$     |                      |              | <0.01         | 0.1            | $\mu A$   |
|                                    |                             |                       |                      |              | 27            |                | $k\Omega$ |
| $t_r$                              | Rise time                   | No load               |                      |              | 4             |                | ns        |
|                                    |                             |                       | slew rate limitation |              | 7             |                |           |

- Notes:
1. The sum of all  $I_{OH}$  for PORTA and PORTB must not exceed 100mA.  
The sum of all  $I_{OH}$  for PORTC, PORTD, PORTE must for each port not exceed 200mA.  
The sum of all  $I_{OH}$  for pins PF[0-5] on PORTF must not exceed 200mA.  
The sum of all  $I_{OL}$  for pins PF[6-7] on PORTF, PORTR and PDI must not exceed 100mA.
  2. The sum of all  $I_{OL}$  for PORTA and PORTB must not exceed 100mA.  
The sum of all  $I_{OL}$  for PORTC, PORTD, PORTE must for each port not exceed 200mA.  
The sum of all  $I_{OL}$  for pins PF[0-5] on PORTF must not exceed 200mA.  
The sum of all  $I_{OL}$  for pins PF[6-7] on PORTF, PORTR and PDI must not exceed 100mA.

| Symbol       | Parameter  | Condition                    | Min. | Typ. | Max. | Units         |
|--------------|--|------------------------------|------|------|------|---------------|
| $t_{SU;STA}$ | Set-up time for a repeated START condition       | $f_{SCL} \leq 100\text{kHz}$ | 4.7  |      |      | $\mu\text{s}$ |
|              |  | $f_{SCL} > 100\text{kHz}$    | 0.6  |      |      |               |
| $t_{HD;DAT}$ | Data hold time                                   | $f_{SCL} \leq 100\text{kHz}$ | 0    |      | 3.45 | $\mu\text{s}$ |
|              |  | $f_{SCL} > 100\text{kHz}$    | 0    |      | 0.9  |               |
| $t_{SU;DAT}$ | Data setup time                                  | $f_{SCL} \leq 100\text{kHz}$ | 250  |      |      | $\text{ns}$   |
|              |  | $f_{SCL} > 100\text{kHz}$    | 100  |      |      |               |
| $t_{SU;STO}$ | Setup time for STOP condition                    | $f_{SCL} \leq 100\text{kHz}$ | 4.0  |      |      | $\mu\text{s}$ |
|              |  | $f_{SCL} > 100\text{kHz}$    | 0.6  |      |      |               |
| $t_{BUF}$    | Bus free time between a STOP and START condition | $f_{SCL} \leq 100\text{kHz}$ | 4.7  |      |      | $\mu\text{s}$ |
|              |  | $f_{SCL} > 100\text{kHz}$    | 1.3  |      |      |               |

- Notes:
- Required only for  $f_{SCL} > 100\text{kHz}$ .
  - $C_b$  = Capacitance of one bus line in pF.
  - $f_{PER}$  = Peripheral clock frequency.

**Table 36-69. Current consumption for modules and peripherals.**

| Symbol          | Parameter                           | Condition <sup>(1)</sup>  | Min.               | Typ. | Max. | Units |
|-----------------|-------------------------------------|---|--------------------|------|------|-------|
| I <sub>CC</sub> | ULP oscillator                      |   |                    | 1.0  |      | µA    |
|                 | 32.768kHz int. oscillator           |   |                    | 27   |      | µA    |
|                 | 2MHz int. oscillator                |   |                    | 85   |      | µA    |
|                 |                                     | DFLL enabled with 32.768kHz int. osc. as reference              |                    | 115  |      | µA    |
|                 | 32MHz int. oscillator               |   |                    | 270  |      | µA    |
|                 |                                     | DFLL enabled with 32.768kHz int. osc. as reference              |                    | 460  |      | µA    |
|                 | PLL                                 | 20x multiplication factor,<br>32MHz int. osc. DIV4 as reference |                    | 220  |      | µA    |
|                 | Watchdog Timer                      |   |                    | 1    |      | µA    |
|                 | BOD                                 | Continuous mode   |                    | 138  |      | µA    |
|                 |                                     | Sampled mode, includes ULP oscillator                           |                    | 1.2  |      | µA    |
|                 | Internal 1.0V reference             |   |                    | 100  |      | µA    |
|                 | Temperature sensor                  |   |                    | 95   |      | µA    |
|                 | ADC                                 | 250ksps<br>$V_{REF} = \text{Ext ref}$                           |                    | 3.0  |      | mA    |
|                 |                                     |   | CURRLIMIT = LOW    | 2.6  |      | mA    |
|                 |                                     |   | CURRLIMIT = MEDIUM | 2.1  |      | mA    |
|                 |                                     |   | CURRLIMIT = HIGH   | 1.6  |      | mA    |
|                 | DAC                                 | 250ksps<br>$V_{REF} = \text{Ext ref}$<br>No load                | Normal mode        | 1.9  |      | mA    |
|                 |                                     |   | Low Power mode     | 1.1  |      | mA    |
|                 | AC                                  | High Speed Mode   |                    | 330  |      | µA    |
|                 |                                     | Low Power Mode  |                    | 130  |      | µA    |
|                 | DMA                                 | 615KBps between I/O registers and SRAM                          |                    | 115  |      | µA    |
|                 | Timer/Counter                       |   |                    | 16   |      | µA    |
|                 | USART                               | Rx and Tx enabled, 9600 BAUD                                    |                    | 2.5  |      | µA    |
|                 | Flash memory and EEPROM programming |   |                    | 4    |      | mA    |

Note: 1. All parameters measured as the difference in current consumption between module enabled and disabled. All data at  $V_{CC} = 3.0V$ ,  $\text{Clk}_{SYS} = 1\text{MHz}$  external clock without prescaling,  $T = 25^\circ\text{C}$  unless other conditions are given. All parameters measured as the difference in current consumption between module enabled and disabled. All data at  $V_{CC} = 3.0V$ ,  $\text{Clk}_{SYS} = 1\text{MHz}$  external clock without prescaling,  $T = 25^\circ\text{C}$  unless other conditions are given.

| Symbol                          | Parameter | Condition             | Min.                              | Typ. | Max. | Units     |
|---------------------------------|-----------|-----------------------|-----------------------------------|------|------|-----------|
| Offset Error,<br>input referred |           | 1x gain, normal mode  |                                   | -2   |      | mV        |
|                                 |           | 8x gain, normal mode  |                                   | -5   |      |           |
|                                 |           | 64x gain, normal mode |                                   | -4   |      |           |
| Noise                           |           | 1x gain, normal mode  | $V_{CC} = 3.6V$<br>Ext. $V_{REF}$ | 0.5  |      | mV<br>rms |
|                                 |           | 8x gain, normal mode  |                                   | 1.5  |      |           |
|                                 |           | 64x gain, normal mode |                                   | 11   |      |           |

Note: 1. Maximum numbers are based on characterisation and not tested in production, and valid for 5% to 95% input voltage range.

### 36.3.7 DAC Characteristics

Table 36-76. Power supply, reference and output range.

| Symbol        | Parameter                   | Condition                               | Min.           | Typ. | Max.             | Units      |
|---------------|-----------------------------|---|----------------|------|------------------|------------|
| $AV_{CC}$     | Analog supply voltage       |   | $V_{CC} - 0.3$ |      | $V_{CC} + 0.3$   |            |
| $AV_{REF}$    | External reference voltage  |   | 1.0            |      | $V_{CC} - 0.6$   | V          |
| $R_{channel}$ | DC output impedance         |   |                |      | 50               | $\Omega$   |
|               | Linear output voltage range |   | 0.15           |      | $AV_{CC} - 0.15$ | V          |
| $R_{AREF}$    | Reference input resistance  |   |                | >10  |                  | $M\Omega$  |
| CAREF         | Reference input capacitance | Static load                             |                | 7    |                  | pF         |
|               | Minimum Resistance load     |   | 1              |      |                  | k $\Omega$ |
|               | Maximum capacitance load    |   |                |      | 100              | pF         |
|               |                             | 1000 $\Omega$ serial resistance         |                |      | 1                | nF         |
|               | Output sink/source          | Operating within accuracy specification |                |      | $AV_{CC}/1000$   | mA         |
|               |                             | Safe operation                          |                |      | 10               |            |

Table 36-77. Clock and timing.

| Symbol    | Parameter       | Condition                               | Min.           | Typ. | Max. | Units |
|-----------|-----------------|---|----------------|------|------|-------|
| $f_{DAC}$ | Conversion rate | $C_{load}=100pF$ ,<br>maximum step size | Normal mode    | 0    | 1000 | ksps  |
|           |                 |   | Low power mode | 0    | 500  |       |

### 36.3.11 External Reset Characteristics

Table 36-82. External reset characteristics.

| Symbol    | Parameter                            | Condition             | Min. | Typ.           | Max. | Units |
|-----------|--------------------------------------|-----------------------|------|----------------|------|-------|
| $t_{EXT}$ | Minimum reset pulse width            |                       |      | 95             | 1000 | ns    |
| $V_{RST}$ | Reset threshold voltage ( $V_{IH}$ ) | $V_{CC} = 2.7 - 3.6V$ |      | 0.60* $V_{CC}$ |      | V     |
|           |                                      | $V_{CC} = 1.6 - 2.7V$ |      | 0.70* $V_{CC}$ |      |       |
|           | Reset threshold voltage ( $V_{IL}$ ) | $V_{CC} = 2.7 - 3.6V$ |      | 0.40* $V_{CC}$ |      |       |
|           |                                      | $V_{CC} = 1.6 - 2.7V$ |      | 0.30* $V_{CC}$ |      |       |
| $R_{RST}$ | Reset pin Pull-up Resistor           |                       |      | 25             |      | kΩ    |

### 36.3.12 Power-on Reset Characteristics

Table 36-83. Power-on reset characteristics.

| Symbol                    | Parameter                              | Condition                         | Min. | Typ. | Max. | Units |
|---------------------------|--|-----------------------------------|------|------|------|-------|
| $V_{POT-}$ <sup>(1)</sup> | POR threshold voltage falling $V_{CC}$ | $V_{CC}$ falls faster than 1V/ms  | 0.4  | 1.0  |      | V     |
|                           |  | $V_{CC}$ falls at 1V/ms or slower | 0.8  | 1.0  |      |       |
| $V_{POT+}$                | POR threshold voltage rising $V_{CC}$  |                                   |      | 1.3  | 1.59 | V     |

Note: 1.  $V_{POT-}$  values are only valid when BOD is disabled. When BOD is enabled  $V_{POT-} = V_{POT+}$ .

### 36.3.13 Flash and EEPROM Memory Characteristics

Table 36-84. Endurance and data retention.

| Symbol | Parameter          | Condition | Min. | Typ. | Max. | Units |
|--------|--------------------|-----------|------|------|------|-------|
| Flash  | Write/Erase cycles | 25°C      | 10K  |      |      | Cycle |
|        |                    | 85°C      | 10K  |      |      |       |
|        |                    | 105°C     | 2K   |      |      |       |
|        | Data retention     | 25°C      | 100  |      |      | Year  |
|        |                    | 85°C      | 25   |      |      |       |
|        |                    | 105°C     | 10   |      |      |       |
| EEPROM | Write/Erase cycles | 25°C      | 100K |      |      | Cycle |
|        |                    | 85°C      | 100K |      |      |       |
|        |                    | 105°C     | 30K  |      |      |       |
|        | Data retention     | 25°C      | 100  |      |      | Year  |
|        |                    | 85°C      | 25   |      |      |       |
|        |                    | 105°C     | 10   |      |      |       |

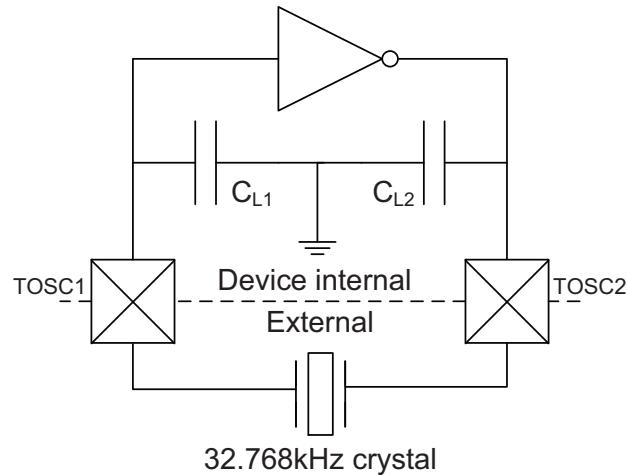
### 36.3.14.8 External 32.768kHz crystal oscillator and TOSC characteristics

**Table 36-94. External 32.768kHz crystal oscillator and TOSC characteristics.**

| Symbol             | Parameter  | Condition   | Min. | Typ. | Max. | Units |
|--------------------|--|---|------|------|------|-------|
| ESR/R1             | Recommended crystal equivalent series resistance (ESR) | Crystal load capacitance 6.5pF                    |      |      | 60   | kΩ    |
|                    |  | Crystal load capacitance 9.0pF                    |      |      | 35   |       |
| C <sub>TOSC1</sub> | Parasitic capacitance TOSC1 pin                        |   |      | 4.2  |      | pF    |
| C <sub>TOSC2</sub> | Parasitic capacitance TOSC2 pin                        |   |      | 4.3  |      | pF    |
|                    | Recommended safety factor                              | capacitance load matched to crystal specification | 3    |      |      |       |

Note: 1. See [Figure 36-4](#) for definition.

**Figure 36-18. TOSC input capacitance.**



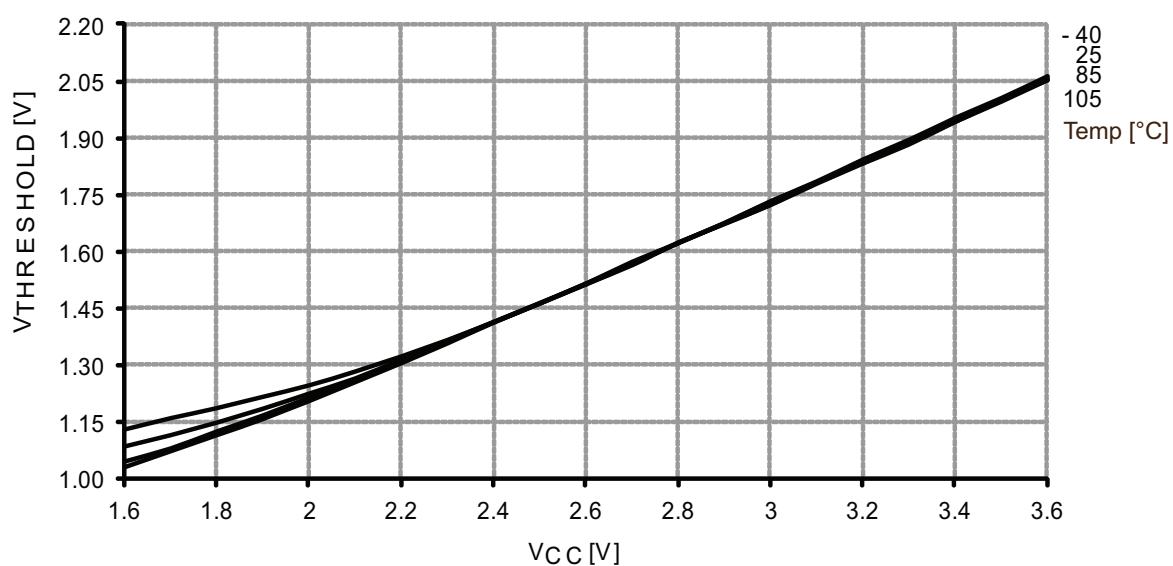
The parasitic capacitance between the TOSC pins is C<sub>L1</sub> + C<sub>L2</sub> in series as seen from the crystal when oscillating without external capacitors.

| Symbol      | Parameter                            | Condition                            | Min.                          | Typ. | Max. | Units          |
|-------------|--------------------------------------|--------------------------------------|-------------------------------|------|------|----------------|
| $R_Q$       | Negative impedance<br><sup>(1)</sup> | XOSCPWR=0,<br>FRQRANGE=0             | 0.4MHz resonator,<br>CL=100pF | 2.4k |      |                |
|             |                                      |                                      | 1MHz crystal, CL=20pF         | 8.7k |      |                |
|             |                                      |                                      | 2MHz crystal, CL=20pF         | 2.1k |      |                |
|             |                                      | XOSCPWR=0,<br>FRQRANGE=1,<br>CL=20pF | 2MHz crystal                  | 4.2k |      |                |
|             |                                      |                                      | 8MHz crystal                  | 250  |      |                |
|             |                                      |                                      | 9MHz crystal                  | 195  |      |                |
|             |                                      | XOSCPWR=0,<br>FRQRANGE=2,<br>CL=20pF | 8MHz crystal                  | 360  |      |                |
|             |                                      |                                      | 9MHz crystal                  | 285  |      |                |
|             |                                      |                                      | 12MHz crystal                 | 155  |      |                |
|             |                                      | XOSCPWR=0,<br>FRQRANGE=3,<br>CL=20pF | 9MHz crystal                  | 365  |      |                |
|             |                                      |                                      | 12MHz crystal                 | 200  |      |                |
|             |                                      |                                      | 16MHz crystal                 | 105  |      |                |
|             |                                      | XOSCPWR=1,<br>FRQRANGE=0,<br>CL=20pF | 9MHz crystal                  | 435  |      |                |
|             |                                      |                                      | 12MHz crystal                 | 235  |      |                |
|             |                                      |                                      | 16MHz crystal                 | 125  |      |                |
|             |                                      | XOSCPWR=1,<br>FRQRANGE=1,<br>CL=20pF | 9MHz crystal                  | 495  |      |                |
|             |                                      |                                      | 12MHz crystal                 | 270  |      |                |
|             |                                      |                                      | 16MHz crystal                 | 145  |      |                |
|             |                                      | XOSCPWR=1,<br>FRQRANGE=2,<br>CL=20pF | 12MHz crystal                 | 305  |      |                |
|             |                                      |                                      | 16MHz crystal                 | 160  |      |                |
|             |                                      | XOSCPWR=1,<br>FRQRANGE=3,<br>CL=20pF | 12MHz crystal                 | 380  |      |                |
|             |                                      |                                      | 16MHz crystal                 | 205  |      |                |
|             | ESR                                  | SF = Safety factor                   |                               |      |      | $\min(R_Q)/SF$ |
| $C_{XTAL1}$ | Parasitic capacitance XTAL1 pin      |                                      |                               |      | 5.2  | pF             |
| $C_{XTAL2}$ | Parasitic capacitance XTAL2 pin      |                                      |                               |      | 6.8  | pF             |
| $C_{LOAD}$  | Parasitic capacitance load           |                                      |                               |      | 2.95 | pF             |

Note: 1. Numbers for negative impedance are not tested in production but guaranteed from design and characterization.

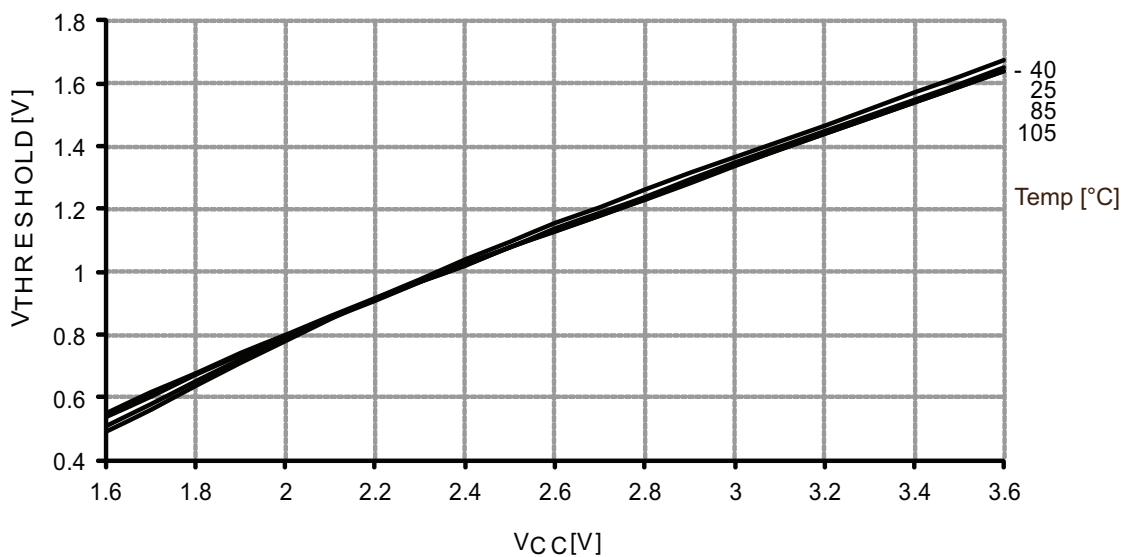
**Figure 37-65. Reset pin input threshold voltage vs.  $V_{CC}$ .**

$V_{IH}$  - Reset pin read as "1".



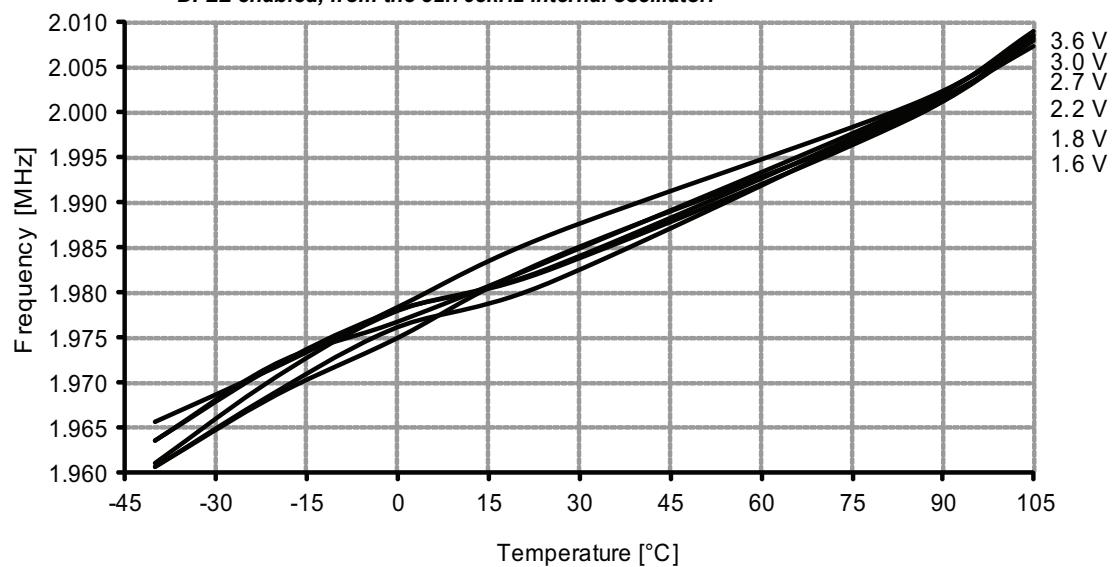
**Figure 37-66. Reset pin input threshold voltage vs.  $V_{CC}$ .**

$V_{IL}$  - Reset pin read as "0".



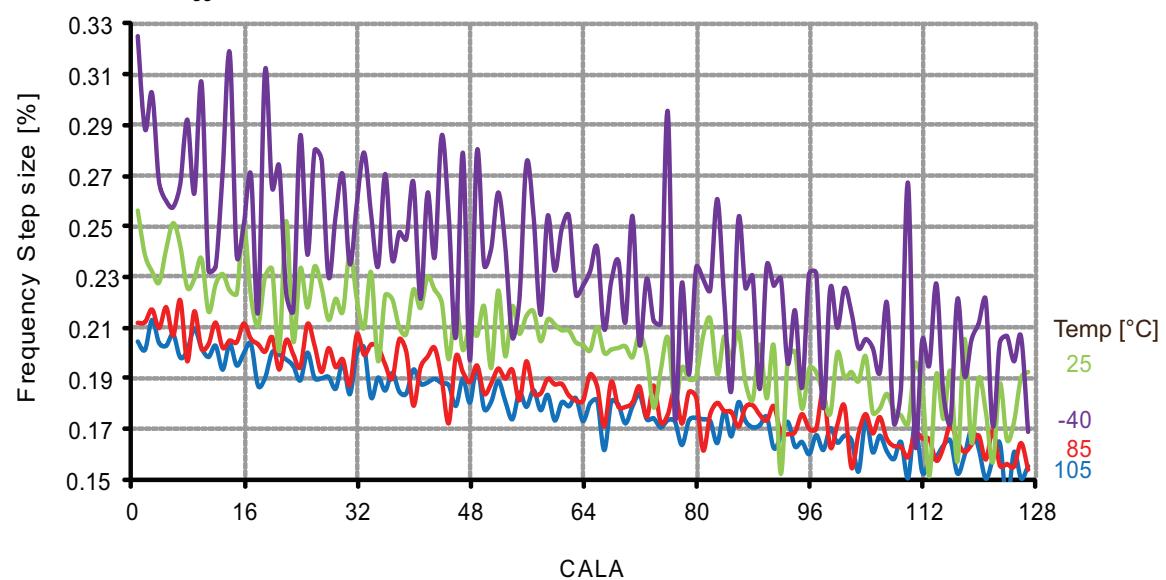
**Figure 37-72.** 2MHz internal oscillator frequency vs. temperature.

*DFLL enabled, from the 32.768kHz internal oscillator.*



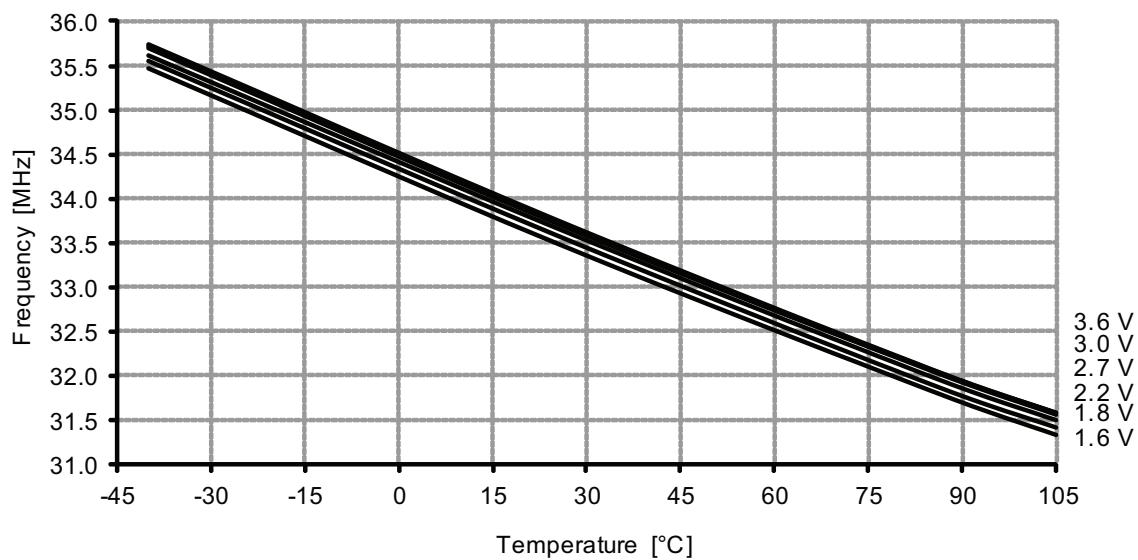
**Figure 37-73.** 2MHz internal oscillator CALA calibration step size.

$V_{CC} = 3V$ .

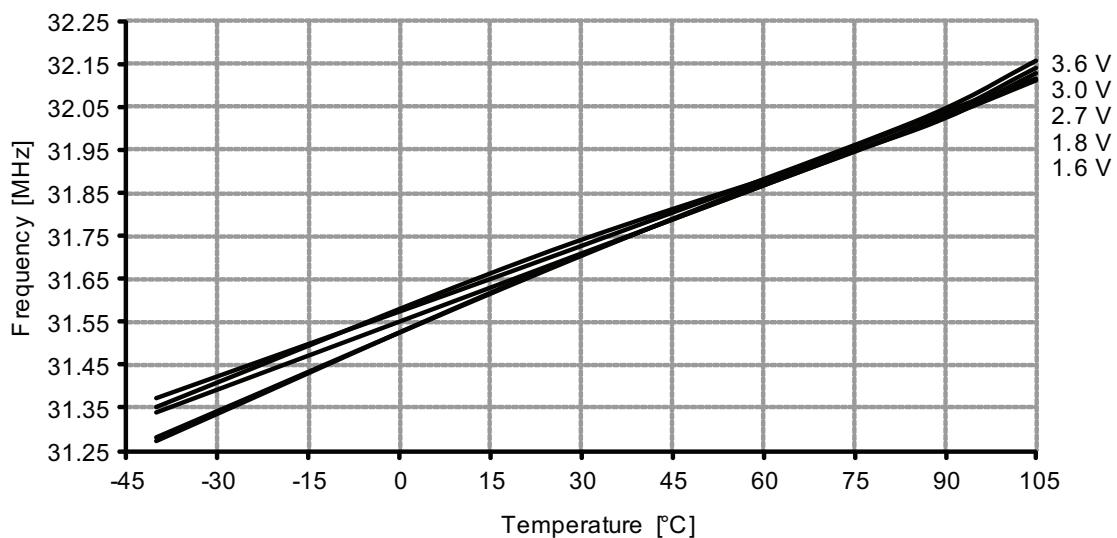


### 37.1.10.4 32MHz Internal Oscillator

**Figure 37-74.** 32MHz internal oscillator frequency vs. temperature.  
*DFLL disabled.*



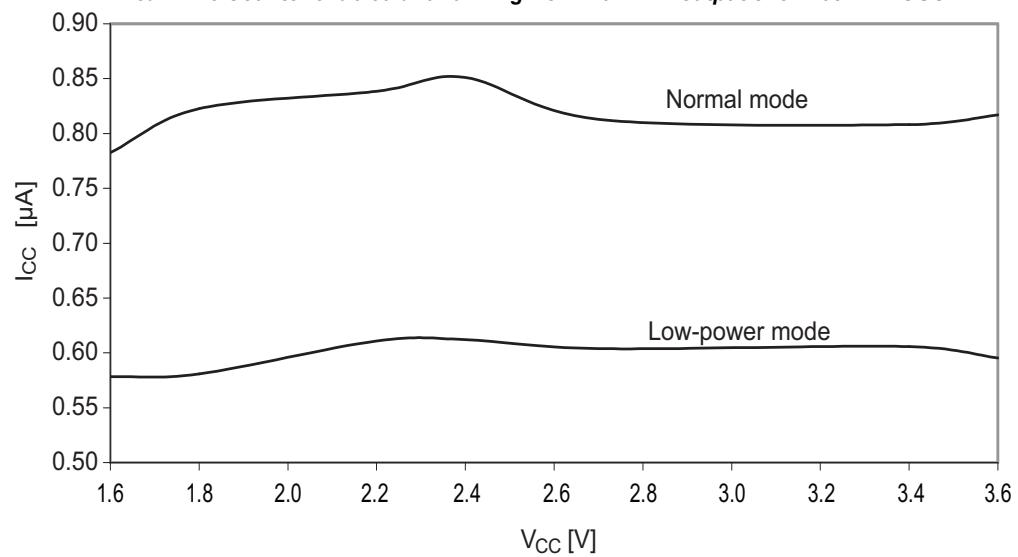
**Figure 37-75.** 32MHz internal oscillator frequency vs. temperature.  
*DFLL enabled, from the 32.768kHz internal oscillator.*



#### 37.2.1.4 Power-save mode supply current

Figure 37-100. Power-save mode supply current vs.  $V_{CC}$ .

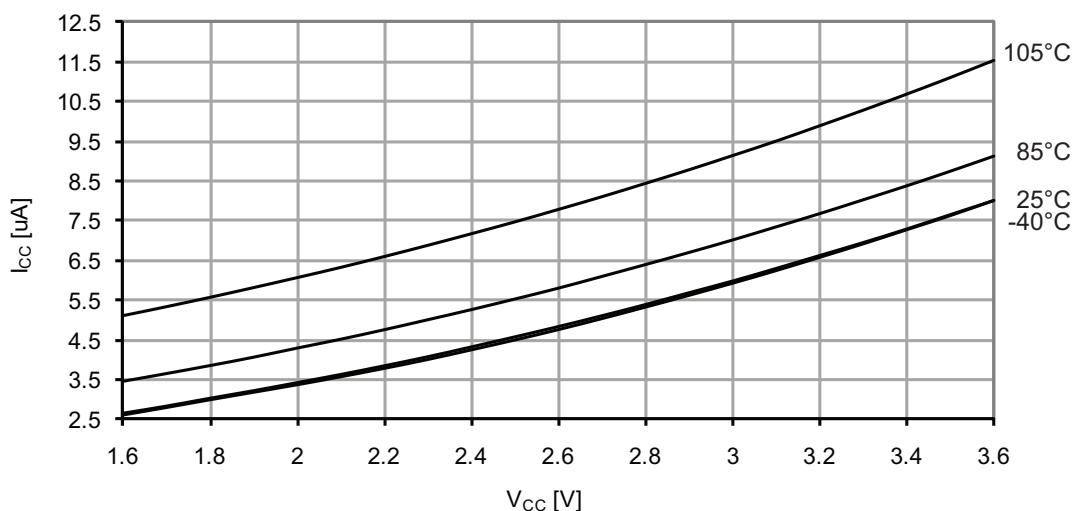
Real Time Counter enabled and running from 1.024kHz output of 32.768kHz TOSC.



#### 37.2.1.5 Standby mode supply current

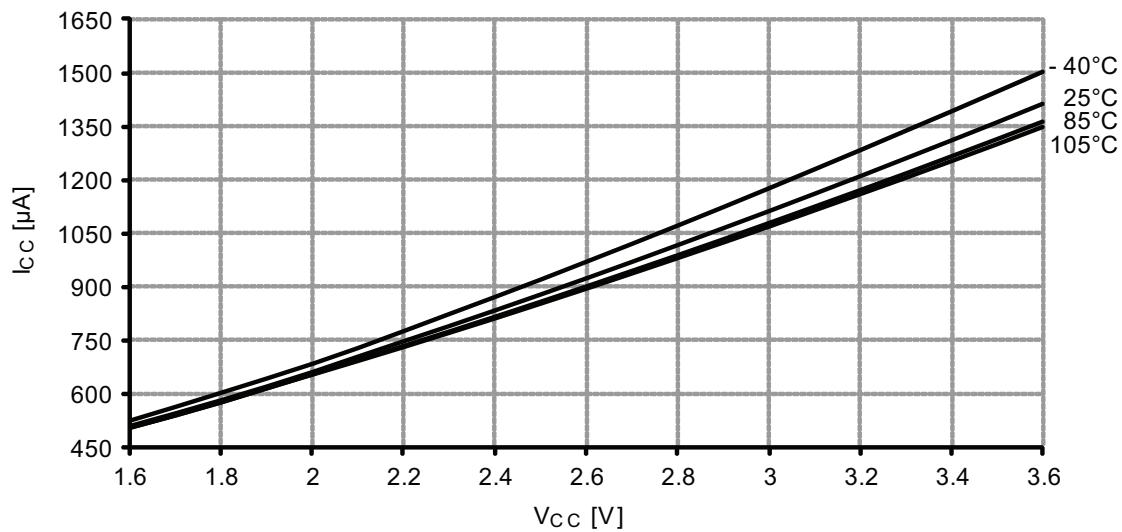
Figure 37-101. Standby supply current vs.  $V_{CC}$ .

Standby,  $f_{SYS} = 1MHz$ .



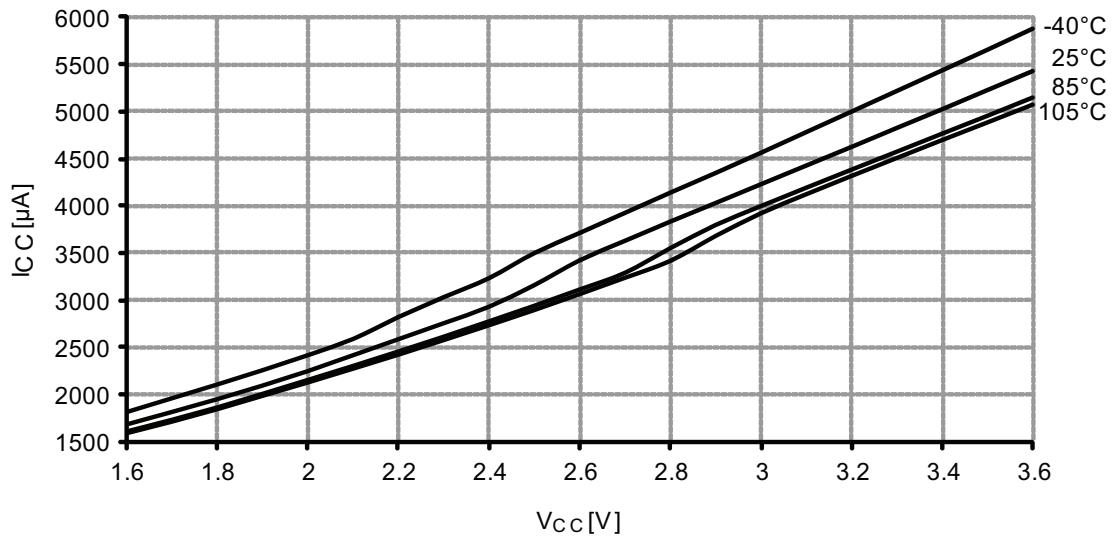
**Figure 37-171. Active mode supply current vs.  $V_{CC}$ .**

$f_{SYS} = 2\text{MHz}$  internal oscillator.



**Figure 37-172. Active mode supply current vs.  $V_{CC}$ .**

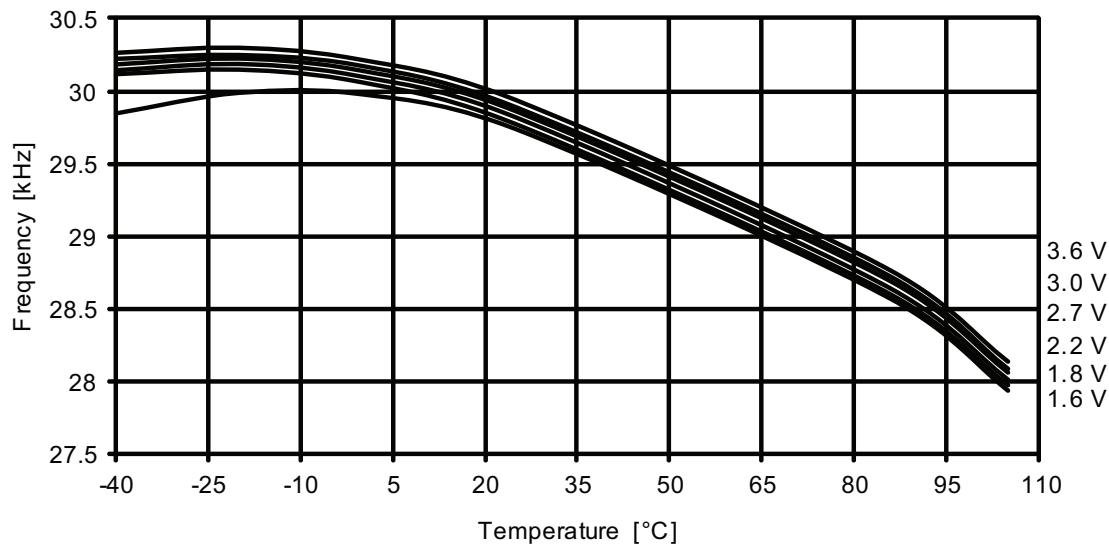
$f_{SYS} = 32\text{MHz}$  internal oscillator prescaled to 8MHz.



### 37.3.10 Oscillator Characteristics

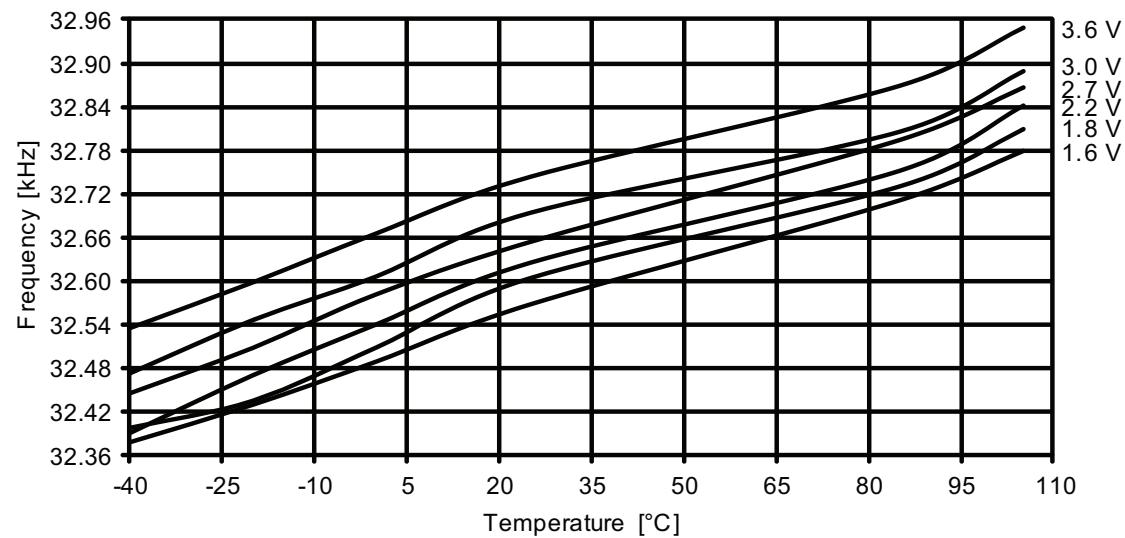
#### 37.3.10.1 Ultra Low-Power internal oscillator

Figure 37-234. Ultra Low-Power internal oscillator frequency vs. temperature.



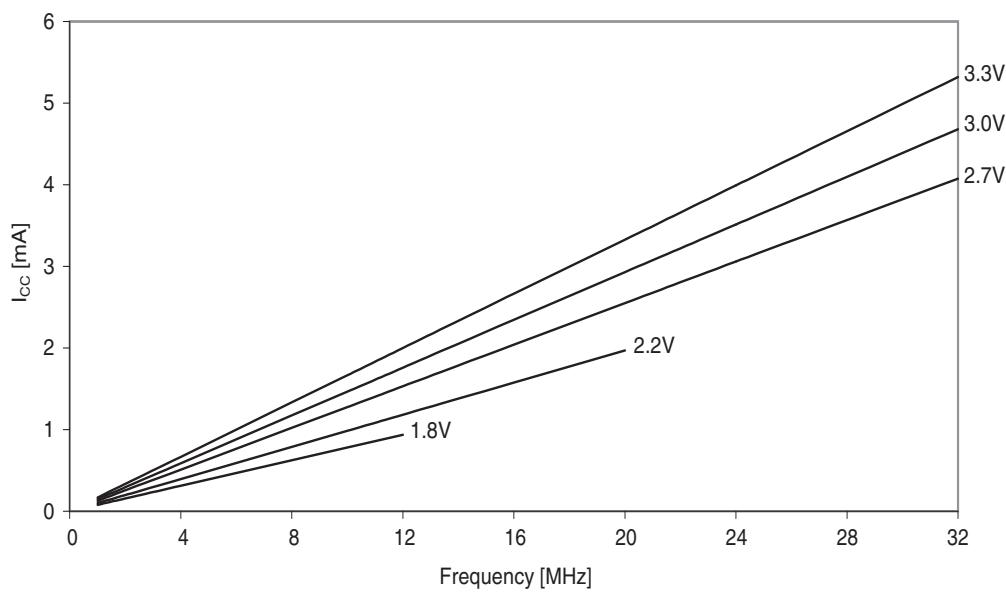
#### 37.3.10.2 32.768kHz Internal Oscillator

Figure 37-235. 32.768kHz internal oscillator frequency vs. temperature.



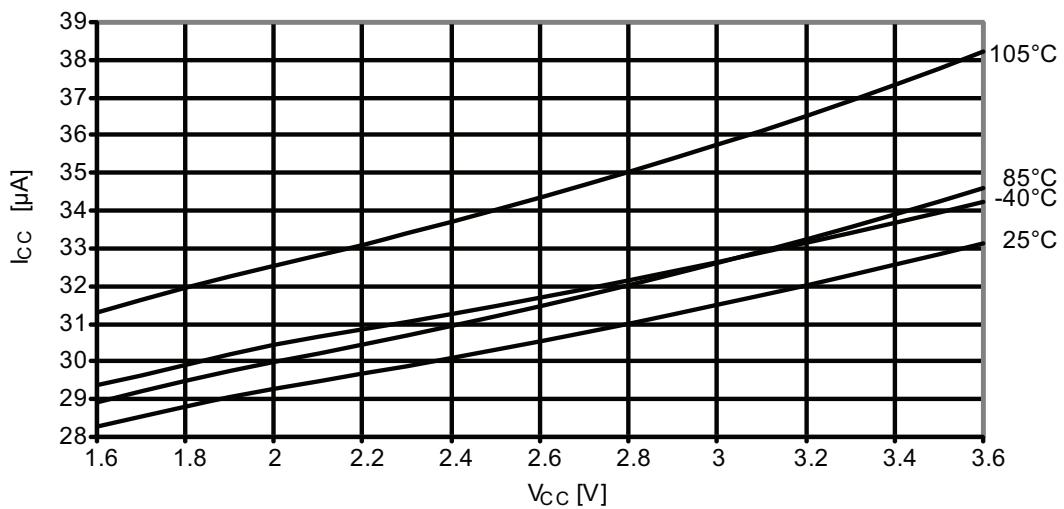
**Figure 37-258. Idle mode supply current vs. frequency.**

$f_{SYS} = 1 - 32MHz$  external clock,  $T = 25^{\circ}C$ .



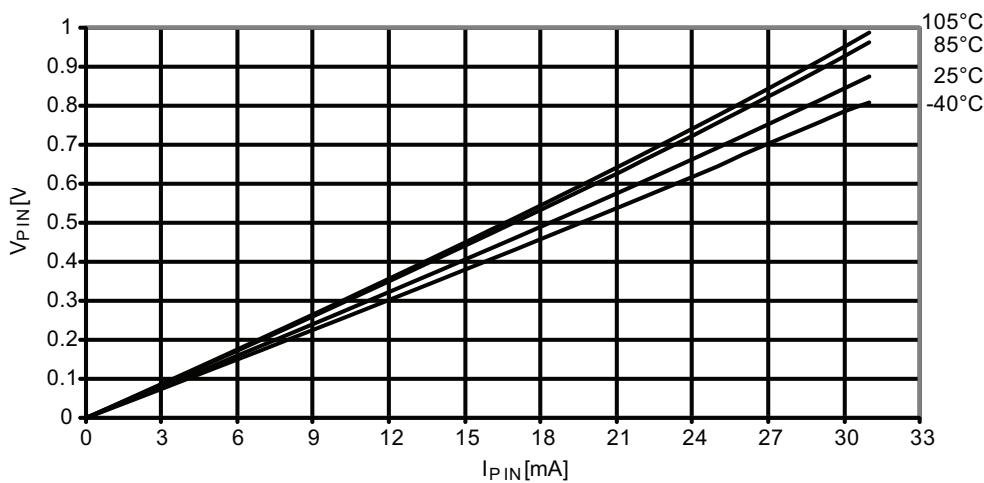
**Figure 37-259. Idle mode supply current vs.  $V_{CC}$ .**

$f_{SYS} = 32.768kHz$  internal oscillator.

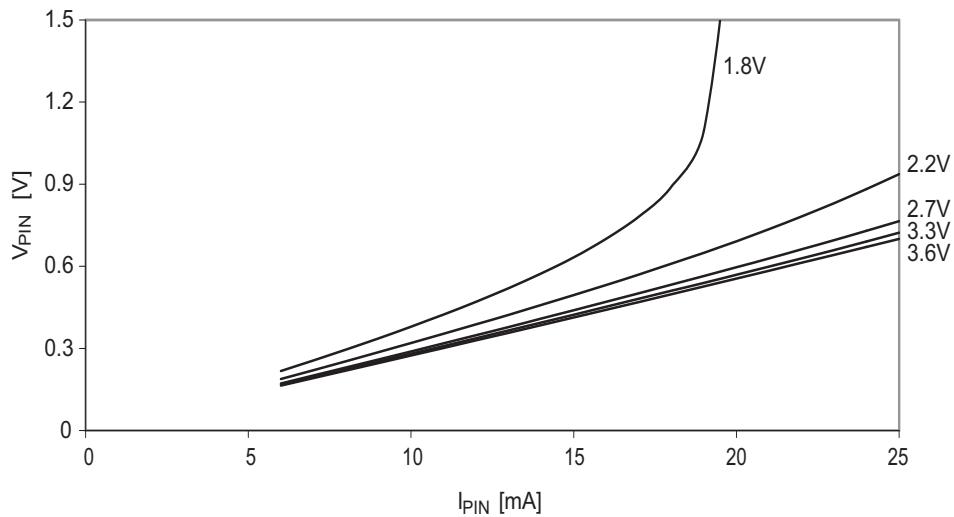


**Figure 37-278. I/O pin output voltage vs. sink current.**

$V_{CC} = 3.3V$ .



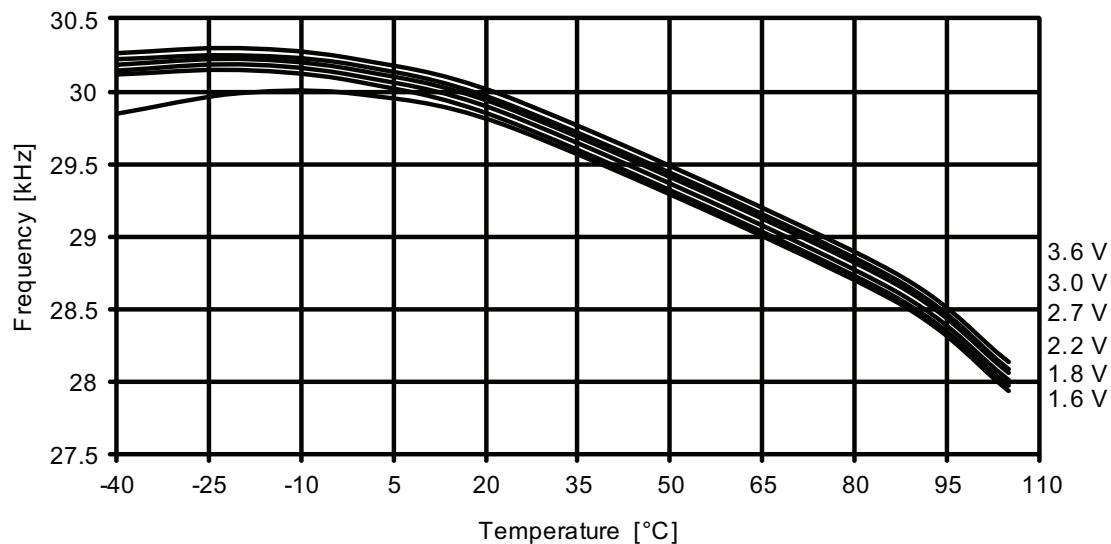
**Figure 37-279. I/O pin output voltage vs. sink current.**



### 37.4.10 Oscillator Characteristics

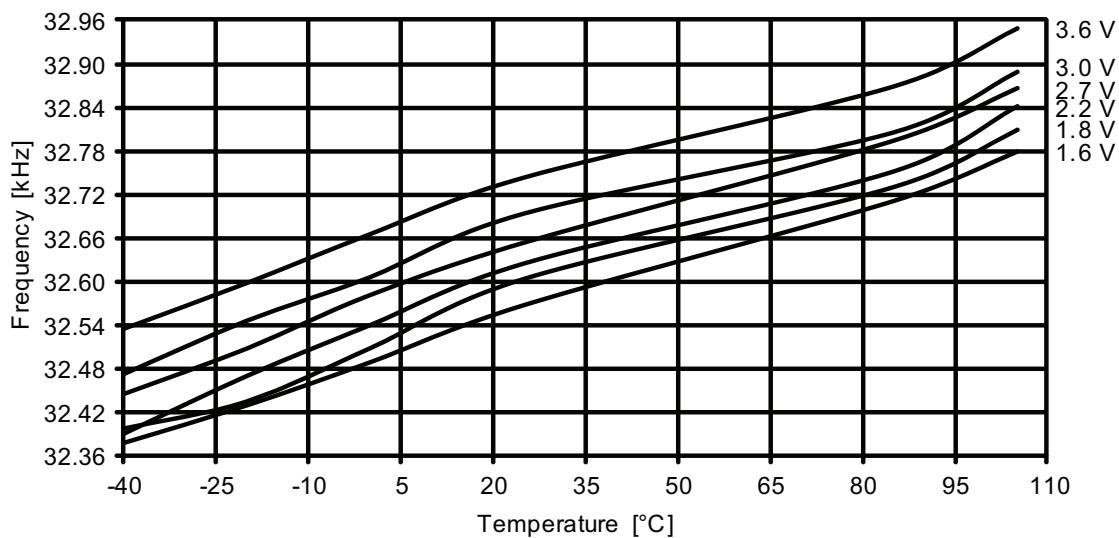
#### 37.4.10.1 Ultra Low-Power internal oscillator

Figure 37-317. Ultra Low-Power internal oscillator frequency vs. temperature.



#### 37.4.10.2 32.768kHz Internal Oscillator

Figure 37-318. 32.768kHz internal oscillator frequency vs. temperature.



## 38. Errata

### 38.1 ATxmega64A3U, ATxmega128A3U, ATxmega192A3U, ATxmega256A3U

#### 38.1.1 Rev. G

- The DAC Channel 1 has not been calibrated in the Xmega devices released prior to April 2012.
- AWeX fault protection restore is not done correct in Pattern Generation Mode.

##### 1. AWeX fault protection restore is not done correct in Pattern Generation Mode

When a fault is detected the OUTOVEN register is cleared, and when fault condition is cleared, OUTOVEN is restored according to the corresponding enabled DTI channels. For Common Waveform Channel Mode (CWCM), this has no effect as the OUTOVEN is correct after restoring from fault. For Pattern Generation Mode (PGM), OUTOVEN should instead have been restored according to the DTLSBUF register.

##### Problem fix/Workaround

Problem fix/Workaround

For CWCM no workaround is required.

For PGM in latched mode, disable the DTI channels before returning from the fault condition. Then, set correct OUTOVEN value and enable the DTI channels, before the direction (DIR) register is written to enable the correct outputs again.

For PGM in cycle-by-cycle mode there is no workaround.

#### 38.1.2 Rev. A-F

Not sampled.

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